Characteristics FERD30SM100S

1 Characteristics

Table 2. Absolute ratings (limiting values, at 25 °C, unless otherwise specified, anode terminals short-circuited)

Symbol	Parameter	Value	Unit
V_{RRM}	Repetitive peak reverse voltage	100	V
I _{F(RMS)}	Forward rms current	60	Α
I _{F(AV)}	Average forward current, $\delta = 0.5$	30	Α
I _{FSM}	Surge non repetitive forward current	250	А
T _{stg}	Storage temperature range	-65 to + 175	°C
T _j ⁽¹⁾	Maximum operating junction temperature	175	°C

^{1.} $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 3. Thermal resistance

Symbol	Parameter	Value (max)	Unit
R _{th(j-c)}	Junction to case	1.6	°C/W

Table 4. Static electrical characteristics (anode terminals short-circuited)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	I _R ⁽¹⁾ Reverse leakage current	T _j = 25 °C	V -V	-	-	150	μΑ
		T _j = 125 °C	$V_R = V_{RRM}$	-	8	16	A
		T _j = 125 °C	V _R = 70 V	-	-	9	mA
V _F ⁽²⁾ For	Forward voltage drop	T _j = 25 °C	I _F = 5 A	-	-	0.475	V
		T _j = 125 °C		-	0.39	0.43	
		T _j = 25 °C	I _F = 10A	-	-	0.585	
		T _j = 125 °C		-	0.50	0.545	
		T _j = 25 °C	I - 30 A	-		0.95	
		T _j = 125 °C	I _F = 30 A	-	0.64	0.71	

^{1.} Pulse test: $t_p = 5 \text{ ms}, \delta < 2\%$

To evaluate the conduction losses use the following equation:

$$P = 0.56 \times I_{F(AV)} + 0.005 I_{F}^{2}_{(RMS)}$$

^{2.} Pulse test: t_p = 380 μ s, δ < 2%

FERD30SM100S Characteristics

Figure 1. Average forward power dissipation versus average forward current

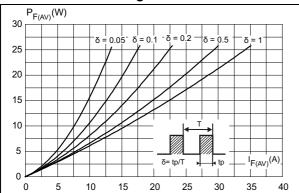


Figure 2. Average forward current versus ambient temperature (δ = 0.5)

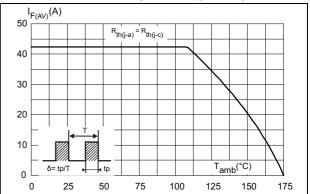
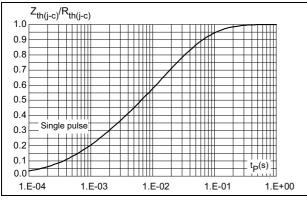


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

Figure 4. Reverse leakage current versus reverse voltage applied (typical values)



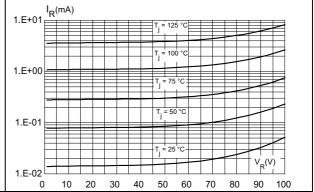
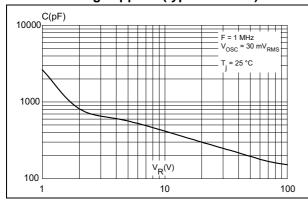
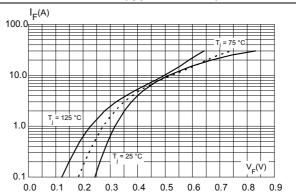


Figure 5. Junction capacitance versus reverse voltage applied (typical values)

Figure 6. Forward voltage drop versus forward current (typical values)





Package information FERD30SM100S

2 **Package information**

Epoxy meets UL94, V0

Cooling method: by conduction (C)

Recommended torque value: 0.55 N·m

Maximum torque value: 0.77 N⋅m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Ε ØP Resin gate 0.5 mm max. protrusion⁽¹⁾ Q H1 D D1 L30 L20 L1 b1 b Resin gate С 0.5 mm max. protrusion(1) (1) Resin gate position accepted in each of the two position shown as well as the symmetrical opposites

Figure 7. TO-220AB dimension definitions

Table 5. TO-220AB dimension values

	Dimensions				
Ref.	Millim	neters	Inches		
	Min.	Max.	Min.	Max.	
А	4.40	4.60	0.17	0.18	
b	0.61	0.88	0.024	0.035	
b1	1.14	1.70	0.045	0.067	
С	0.48	0.70	0.019	0.027	
D	15.25	15.75	0.60	0.62	
D1	1.27 typ.		0.05 typ.		
E	10	10.40	0.39	0.41	
е	2.40	2.70	0.094	0.106	
e1	4.95	5.15	0.19	0.20	
F	1.23	1.32	0.048	0.052	
H1	6.20	6.60	0.24	0.26	
J1	2.40	2.72	0.094	0.107	
L	13	14	0.51	0.55	
L1	3.50	3.93	0.137	0.154	
L20	16.40 typ.		0.64 typ.		
L30	28.90 typ.		1.13 typ.		
ØP	3.75	3.85	0.147	0.151	
Q	2.65	2.95	0.104	0.116	

Ordering information FERD30SM100S

3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
FERD30SM100ST	FERD30SM100ST	TO-220AB	1.9 g	50	Tube

4 Revision history

Table 7. Document revision history

Date	Revision	Changes
12-Jan-2015	1	Initial release.

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